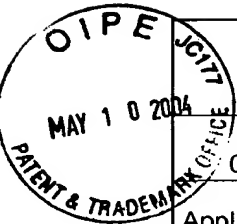


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AMENDMENT TRANSMITTAL LETTER

Docket No.
M4065.0454/P454

Application No. 09/929,350-Conf. #8862	Filing Date August 15, 2001	Examiner C. C. Chu	Art Unit 2815
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Applicant(s): Jerome Eldridge et al.

INTERNAL HYDROGEN SOURCES FOR HEAT CONDUCTIVE PACKAGING OF LOW
Invention: DIELECTRIC CONSTANT SEMICONDUCTOR CHIPS, AND METHOD OF PROVIDING
HYDROGEN THEREFOR

TO THE COMMISSIONER FOR PATENTS

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

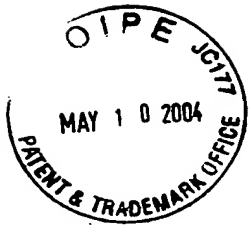
CLAIMS AS AMENDED					
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate	
Total Claims	62	- 183 =		x	0.00
Independent Claims	9	- 18 =		x	0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					
Other fee (please specify):					
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:					0.00

- ☒ Large Entity ☐ Small Entity
- ☒ No additional fee is required for this amendment.
- ☐ Please charge Deposit Account No. _____ in the amount of \$ _____.
A duplicate copy of this sheet is enclosed.
- ☐ A check in the amount of \$ _____ to cover the filing fee is enclosed.
- ☐ Payment by credit card. Form PTO-2038 is attached.
- ☒ The Director is hereby authorized to charge and credit Deposit Account No. 04-1073
as described below. A duplicate copy of this sheet is enclosed.
- ☒ Credit any overpayment.
- ☒ Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.

Thomas J. D'Amico
Attorney Reg. No.: 28,371

Dated: May 10, 2004

DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP
2101 L Street NW
Washington, DC 20037-1526
(202) 828-2232



Docket No.: M4065.0454/P454
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Jerome Eldridge et al.

Application No.: 09/929,350

Art Unit: 2815

Filed: August 15, 2001

Examiner: C. C. Chu

For: INTERNAL HYDROGEN SOURCES FOR
HEAT CONDUCTIVE PACKAGING OF
LOW DIELECTRIC CONSTANT
SEMICONDUCTOR CHIPS, AND
METHOD OF PROVIDING HYDROGEN
THEREFOR

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated February 9, 2004 (Paper No. 17), please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 38 of this paper.